



DFLS120L

1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER PowerDI123

Features

- Guard Ring Die Construction for Transient Protection
- · Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- High Current Capability and Low Forward Voltage Drop
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An Automotive-Compliant Part is Available Under Separate Datasheet (DFLS120LQ)

Mechanical Data

- Package: PowerDI[®]123
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.01 grams (Approximate)

PowerDI123



Top View

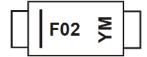
Ordering Information (Note 4)

Part Number	Packago	Packing		
Part Number	Package	Qty.	Carrier	
DFLS120L-7	PowerDI123	3000	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



F02 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: J = 2022) M = Month (ex: 9 = September)



Date Code Key

Year	2004		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	R		J	K	L	М	N	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	4	2	2	1	5	6	7	ο	۵	0	N	D



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RM} V _{RWM} V _R	20	٧
RMS Reverse Voltage	V _R (RMS)	14	V
Average Forward Current	I _{F(AV)}	1.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	50	A

Thermal Characteristics

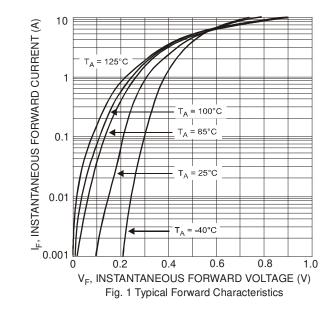
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.67	W
Power Dissipation (Note 6)	PD	556	mW
Thermal Resistance Junction to Ambient (Note 5)	Reja	60	°C/W
Thermal Resistance Junction to Ambient (Note 6)	Reja	180	°C/W
Thermal Resistance Junction to Soldering (Note 7)	Reus	10	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

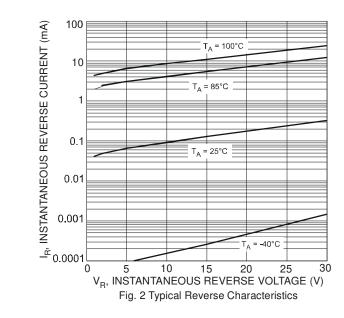
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

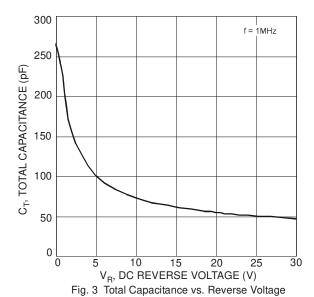
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	$V_{(BR)R}$	20	-	_	V	I _R = 1.0mA
Forward Voltage	VF		0.20 0.30 0.32	— — 0.36	٧	IF = 0.1A IF = 0.7A IF = 1.0A
Leakage Current (Note 8)	IR		0.26 —	 1.0	mA	V _R = 5V, T _A = +25°C V _R = 20V, T _A = +25°C
Total Capacitance	Ст	_	75	_	pF	V _R = 10V, f = 1.0MHz

- 5. Part mounted on 50.8mm x 50.8mm GETEK board with 25.4mm x 25.4mm copper pad, 25% anode, 75% cathode. T_A = +25°C.
- 6. Part mounted on FR-4 board with 1.8mm x 2.5mm cathode and 1.8mm x 1.2mm anode, 1 oz. copper pads. $T_A = +25^{\circ}C$. 7. Theoretical R_{BUS} calculated from the top center of the die straight down to the PCB/cathode tab solder junction.
- 8. Short duration pulse test used to minimize self-heating effect.







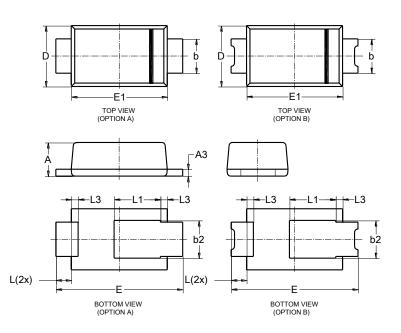




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123

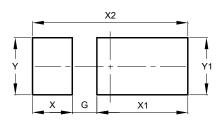


PowerDI123						
Dim	Min	Max	Тур			
Α	0.93	1.00	0.98			
A3	0.15	0.25	0.20			
b	0.85	1.25	1.00			
b2	1.025	1.125	1.10			
D	1.63	1.93	1.78			
Е	3.50	3.90	3.70			
E1	2.60	3.00	2.80			
L	0.40	0.50	0.45			
L1	1.25	1.40	1.35			
L3	0.125	0.275	0.20			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123



Dimensions	Value (in mm)		
G	0.65		
X	1.05		
X1	2.40		
X2	4.10		
Y	1.50		
Y1	1.50		

August 2022



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